Application No. 10/054,331

Docket No. A4-1763

Amendment dated October 27, 2004

Reply to Office Action of July 30, 2004

Amendments to the Specification:

Please replace the title of the invention at page 1 with the following amended title:

MEMS CAPACITIVE SENSOR IMPLANTABLE SENSING

DEVICE FOR PHYSIOLOGIC PARAMETER MEASUREMENT

Please replace paragraph [0009] with the following amended paragraph:

[0009] Also an object of this invention is to a microfabricated microfabricated sensing device adapted for implantation within the body of patient in which active circuitry is integrated into the sensing device.

Please replace paragraph [0010] with the following amended paragraph:

[0010] A further object of the invention is to provide a microfabricated implantable sensing device capacitive pressure sensor exhibiting high stability and low drift.

Please delete [0011].

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Please replace paragraph [0012] with the following amended paragraph:

[0012] In overcoming the limitations of the prior art and achieving the above

objects, the present invention provides for a MEMS sensing device for

implantation into the body of a patient and which permits conditioning and

analysis of the signal from a capacitive sensor portion of the device on the device

itself.

Please replace paragraph [0013] with the following amended paragraph:

[0013] In achieving the above, the present invention provides a MEMS sensing

device in which the sensing and signal conditioning components are located on a

monolithic structure that can be entirely implanted in the human body. The

monolithic structure the same chip. The implanted device includes a substrate

on which a sensor is integrally microfabricated and configured to be responsive to

a physiologic parameter of a patient's body. For example, the sensor may be a

capacitive sensor adapted to measure pressure, e.g., blood pressure. is formed a

capacitive sensor. The fixed electrode of the capacitive sensor may formed on the

substrate itself, while the moveable electrode of the capacitive sensor is formed as

part of a highly doped silicon layer on top of the substrate. Being highly doped,

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the silicon layer itself operates as the conductive path for the moveable electrode.

A separate conductive path is provided on the substrate for the fixed electrode.

Please replace paragraph [0014] with the following amended paragraph:

[0014] In addition to the capacitive sensor, the monolithic structure of the

<u>implantable</u> the implanted sensing device includes active circuitry that

conditions the signal from the sensor for immediate signal processing, for

example, data capacitive sensor and which immediately begins processing of the

data, including logging, error correction, encoding, analysis and/or multiplexing

of multiple sensor inputs. As such, the active circuitry may be integrally

microfabricated in the substrate a highly doped silicon layer during

microfabrication of the sensor and employing the same fabrication techniques.

Alternatively, the active circuitry may be added may added to the substrate of the

device after initial microfabrication of the sensor sensor itself and thereafter

connected to the sensor through wirebonds or leads integrally fabricated with the

sensor.

Please replace paragraph [0015] with the following amended paragraph:

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[0015] Locating this circuitry on the monolithic structure in close proximity as

near as possible to the microfabricated sensor minimizes parasitic effects and

other factors that could lead to degradation in the received signal and error in the

measured physiologic parameter. Further objects object and advantages of the

present invention will become apparent to those skilled in the art from a review of

the drawings in connection with the following description and dependent claims.

Please replace paragraph [0029] with the following amended paragraph:

[0029] FIG. 13B is an embodiment generally similar to that seen in FIG. 13A

FIG. 23 for sensing according to the principles of the present invention;

Please replace paragraph [0057] with the following amended paragraph:

[0057] FIG. 13A illustrates a sensing device 512 having an alternative capacitive

pressure sensor 518 sensor 556 on a substrate 520, additional structures are

omitted for clarity. In this sensor 518, sensor 556, the capacitance changes due to

a varying dielectric constant within the capacitive gap defined between electrodes

558 and 560. 158 and 160. The gap is filled with sensing substance 562 chosen

such that its dielectric constant changes in response to the particular physiologic

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stimulus being evaluated. FIG. 13B depicts an alternate implementation of the above embodiment, with the electrodes 558' and 560' and the sensing substance 562' substance 562' being stacked vertically on the substrate 520, as opposed to the lateral orientation in FIG. 13A.